

## **GaAs INTEGRATED CIRCUIT**

# $\mu$ PG2163T5N

#### SPDT SWITCH FOR 2.4 GHz AND 6 GHz DUAL-BAND WIRELESS LAN

#### **DESCRIPTION**

The  $\mu$ PG2163T5N is GaAs MMIC SPDT (<u>Single Pole Double Throw</u>) switch which was developed for 2.4 GHz and 6 GHz dual-band wireless LAN. This device can operate frequency from 2.4 GHz band and 6 GHz band, having the low insertion loss and high isolation.

This device is housed in a 6-pin plastic TSON (Thin Small Out-line Non-leaded) package. And this package is able to high-density surface mounting.

#### **FEATURES**

Operating frequency : f = 2.4 to 2.5 GHz and 4.9 to 6.0 GHz
 Switch control voltage : V<sub>cont (H)</sub> = 2.8 to 5.0 V (3.0 V TYP.)

:  $V_{cont(L)} = -0.3 \text{ to } 0.3 \text{ V (0 V TYP.)}$ 

Low insertion loss
 : Lins1 = 0.40 dB TYP. @ f = 2.4 to 2.5 GHz, Vcont (H) = 3.0 V, Vcont (L) = 0 V

: Lins2 = 0.50 dB TYP. @ f = 4.9 to 6.0 GHz,  $V_{cont(H)}$  = 3.0 V,  $V_{cont(L)}$  = 0 V

High isolation
 : ISL1 = 38 dB TYP. @ f = 2.4 to 2.5 GHz, V<sub>cont</sub> (H) = 3.0 V, V<sub>cont</sub> (L) = 0 V

: ISL2 = 30 dB TYP. @ f = 4.9 to 6.0 GHz,  $V_{cont(H)}$  = 3.0 V,  $V_{cont(L)}$  = 0 V

• Handling power :  $P_{in (1 dB)} = +31.0 dBm TYP$ . @ f = 2.5 GHz,  $V_{cont (H)} = 3.0 V$ ,  $V_{cont (L)} = 0 V$ 

: Pin (1 dB) = +29.0 dBm TYP. @ f = 6.0 GHz,  $V_{cont}$  (H) = 3.0 V,  $V_{cont}$  (L) = 0 V

High-density surface mounting: 6-pin plastic TSON package (1.5 × 1.5 × 0.37 mm)

#### **APPLICATIONS**

• Dual-band wireless LAN (IEEE802.11a + b/g)

#### **ORDERING INFORMATION**

Part Num	ber	Order Number	Package	Marking	Supplying Form
μPG2163T5	iN-E2	μPG2163T5N-E2-A	6-pin plastic TSON (Pb-Free)	G4X	Embossed tape 8 mm wide     Pin 1, 6 face the perforation side of the tape     Qty 3 kpcs/reel

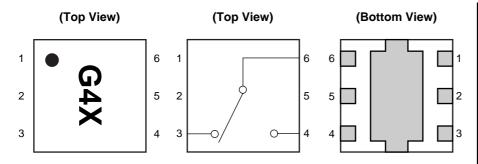
**Remark** To order evaluation samples, contact your nearby sales office.

Part number for sample order: μPG2163T5N

Caution Observe precautions when handling because these devices are sensitive to electrostatic discharge.

The information in this document is subject to change without notice. Before using this document, please confirm that this is the latest version.

## PIN CONNECTIONS AND INTERNAL BLOCK DIAGRAM



Pin No.	Pin Name
1	GND
2	V <sub>cont</sub> 2
3	OUT2 (RX)
4	OUT1 (TX)
5	V <sub>cont</sub> 1
6	IN (ANT)

Remark Exposed pad: GND

#### TRUTH TABLE

V <sub>cont</sub> 1	V <sub>cont</sub> 2	IN (ANT)-OUT1 (TX)	IN (ANT)-OUT2 (RX)	
High	Low	OFF	ON	
Low	High	ON	OFF	

#### ABSOLUTE MAXIMUM RATINGS (TA = +25°C, unless otherwise specified)

Parameter	Symbol	Ratings	Unit
Switch Control Voltage	Vcont	-6.0 to +6.0	V
Input Power	Pin	+32	dBm
Operating Ambient Temperature	TA	-45 to +85	°C
Storage Temperature	T <sub>stg</sub>	-55 to +135	°C

## RECOMMENDED OPERATING RANGE (TA = +25°C, unless otherwise specified)

Parameter	Symbol	MIN.	TYP.	MAX.	Unit
Switch Control Voltage (H)	V <sub>cont (H)</sub>	2.8	3.0	5.0	V
Switch Control Voltage (L)	V <sub>cont (L)</sub>	-0.3	0	0.3	٧
Operating Frequency 1	f1	2.4	1	2.5	GHz
Operating Frequency 2	f2	4.9	ı	6.0	GHz

#### **ELECTRICAL CHARACTERISTICS**

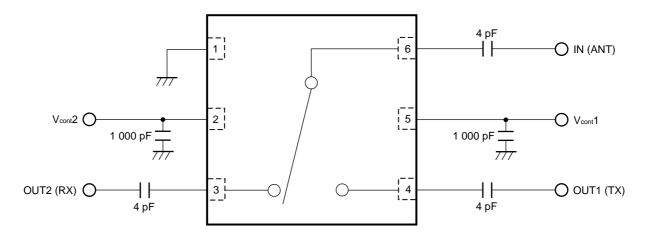
(TA = +25°C,  $V_{cont}$  (H) = 3.0 V,  $V_{cont}$  (L) = 0 V,  $Z_0$  = 50  $\Omega$ , DC blocking capacitors = 4 pF, unless otherwise specified)

Parameter	Symbol	Test Conditions	MIN.	TYP.	MAX.	Unit
Insertion Loss 1	Lins1	f = 2.4 to 2.5 GHz	-	0.40	0.60	dB
Insertion Loss 2	Lins2	f = 4.9 to 6.0 GHz	-	0.50	0.80	dB
Isolation 1	ISL1	f = 2.4 to 2.5 GHz	35	38	_	dB
Isolation 2	ISL2	f = 4.9 to 6.0 GHz	27	30	=	dB
Input Return Loss 1	RLin1	f = 2.4 to 2.5 GHz	=	15	=	dB
Input Return Loss 2	RLin2	f = 4.9 to 6.0 GHz	-	15	_	dB
Output Return Loss 1	RLout1	f = 2.4 to 2.5 GHz	-	15	_	dB
Output Return Loss 2	RLout2	f = 4.9 to 6.0 GHz	-	15	_	dB
1 dB Loss Compression Input Power 1 Note	Pin (1 dB) 1	f = 2.4 to 2.5 GHz	-	+31.0	-	dBm
1 dB Loss Compression Input Power 2 Note	Pin (1 dB) 2	f = 4.9 to 6.0 GHz	-	+29.0	-	dBm
Input 3rd Order Distortion Intercept Point	IIP3		=	+55	-	dBm
Switch Control Current	Icont		-	0.1	1.0	μА
Switch Control Speed	tsw	50% CTL to 90/10%	-	50	-	ns

**Note** Pin (1 dB) is measured the input power level when the insertion loss increases more 1 dB than that of linear range.

Caution This device is used it is necessary to use DC blocking capacitors.

#### **EVALUATION CIRCUIT**

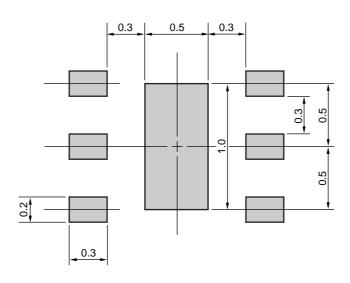


The application circuits and their parameters are for reference only and are not intended for use in actual design-ins.

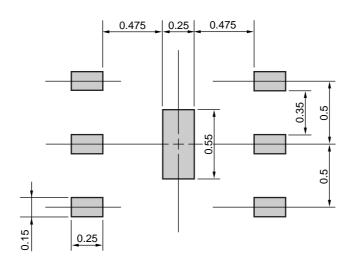
#### **MOUNTING PAD DIMENSIONS**

## 6-PIN PLASTIC TSON (UNIT: mm)

#### **MOUNTING PAD**



#### **SOLDER PAD**

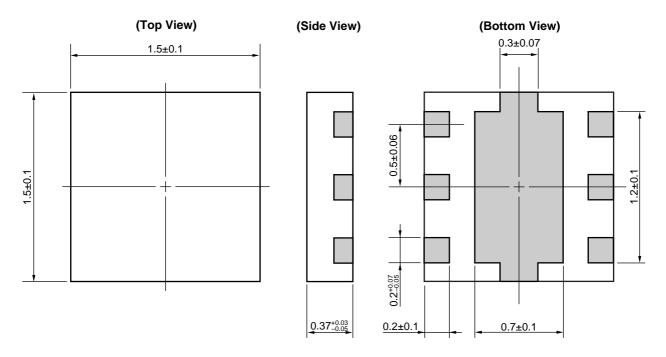


Solder thickness: 0.08 mm

**Remark** The mounting pad layouts in this document are for reference only.

## PACKAGE DIMENSIONS

## 6-PIN PLASTIC TSON (UNIT: mm)



#### RECOMMENDED SOLDERING CONDITIONS

This product should be soldered and mounted under the following recommended conditions. For soldering methods and conditions other than those recommended below, contact your nearby sales office.

Soldering Method	Soldering Conditions		Condition Symbol
Infrared Reflow	Peak temperature (package surface temperature) Time at peak temperature Time at temperature of 220°C or higher Preheating time at 120 to 180°C Maximum number of reflow processes Maximum chlorine content of rosin flux (% mass)	: 260°C or below : 10 seconds or less : 60 seconds or less : 120±30 seconds : 3 times : 0.2%(Wt.) or below	IR260
Wave Soldering	Peak temperature (molten solder temperature) Time at peak temperature Preheating temperature (package surface temperature) Maximum number of flow processes Maximum chlorine content of rosin flux (% mass)	: 260°C or below : 10 seconds or less : 120°C or below : 1 time : 0.2%(Wt.) or below	WS260
Partial Heating	Peak temperature (terminal temperature) Soldering time (per side of device) Maximum chlorine content of rosin flux (% mass)	: 350°C or below : 3 seconds or less : 0.2%(Wt.) or below	HS350

Caution Do not use different soldering methods together (except for partial heating).



4590 Patrick Henry Drive Santa Clara, CA 95054-1817 Telephone: (408) 919-2500

Facsimile: (408) 988-0279

Subject: Compliance with EU Directives

CEL certifies, to its knowledge, that semiconductor and laser products detailed below are compliant with the requirements of European Union (EU) Directive 2002/95/EC Restriction on Use of Hazardous Substances in electrical and electronic equipment (RoHS) and the requirements of EU Directive 2003/11/EC Restriction on Penta and Octa BDE.

CEL Pb-free products have the same base part number with a suffix added. The suffix –A indicates that the device is Pb-free. The –AZ suffix is used to designate devices containing Pb which are exempted from the requirement of RoHS directive (\*). In all cases the devices have Pb-free terminals. All devices with these suffixes meet the requirements of the RoHS directive.

This status is based on CEL's understanding of the EU Directives and knowledge of the materials that go into its products as of the date of disclosure of this information.

Restricted Substance per RoHS	Concentration Limit per RoHS (values are not yet fixed)	Concentration contained in CEL devices		
Lead (Pb)	< 1000 PPM	-A Not Detected	-AZ (*)	
Mercury	< 1000 PPM	Not Detected		
Cadmium	< 100 PPM	Not Detected		
Hexavalent Chromium	< 1000 PPM	Not Detected		
PBB	< 1000 PPM	Not Detected		
PBDE	< 1000 PPM	Not Detected		

If you should have any additional questions regarding our devices and compliance to environmental standards, please do not hesitate to contact your local representative.

Important Information and Disclaimer: Information provided by CEL on its website or in other communications concerting the substance content of its products represents knowledge and belief as of the date that it is provided. CEL bases its knowledge and belief on information provided by third parties and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. CEL has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. CEL and CEL suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

In no event shall CEL's liability arising out of such information exceed the total purchase price of the CEL part(s) at issue sold by CEL to customer on an annual basis.

See CEL Terms and Conditions for additional clarification of warranties and liability.